

A

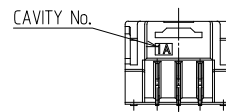
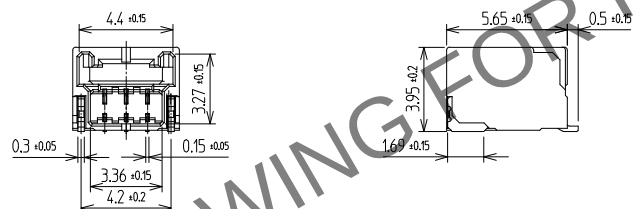
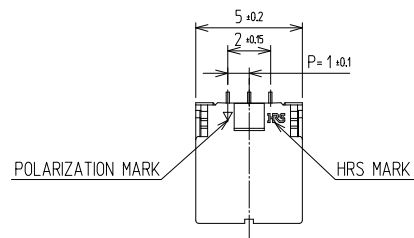
B

C

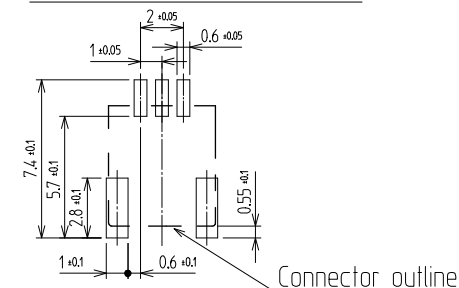
D

E

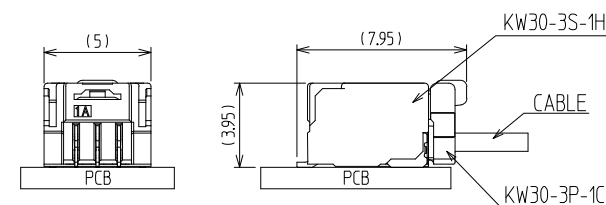
F



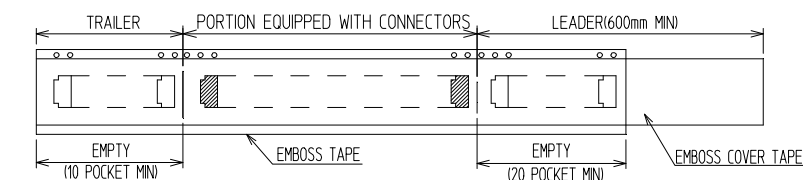
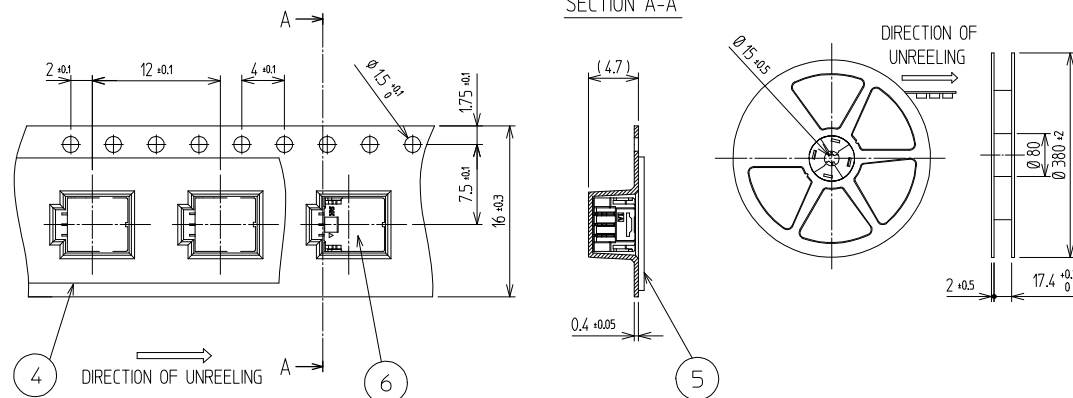
RECOMMENDED PCB LAYOUT (Top-View)



MATING FIGURE



SECTION A-A



NOTE

1. LEAD CO-PLANARITY SHALL BE 0.1mmMAX
2. 1REEL : 1500EA CONNECTORS
3. UL(File No. E132750) AUTHORIZATION ARTICLE.
C-UL(File No. E132750) AUTHORIZATION ARTICLE.



3	COPPER ALLOY	CONTACT AREA : GOLD 0.2 μ m MIN. SMT LEAD : GOLD 0.05 μ m MIN. UNDER PLATING : NICKEL 1 μ m MIN.	6	CONNECTOR	KW30-3S-1H
2	PHOSPHOR BRONZE	Sn PLATED	5	PET	COVER TAPE
1	LCP	UL94-V0, BLACK	4	PS	EMBOS CARRIER TAPE
NO.	MATERIAL	FINISH,REMARKS	NO.	MATERIAL	FINISH,REMARKS
CODE NO. (OLD)			DRAWN	DESIGNED	CHECKED
			CHOI 20.06.05 S.W	CHOI 20.06.05 S.W	LIM 20.06.12 S.M
APPROVED			RELEASED		
DRAWING NO. EDC3-633092			PART NO. KW30-3S-1H (800)		
SCALE 4:1			CODE NO. CL 6669-0005-4-800		
UNITS mm			1/1		